Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-30	V
Collector-Emitter Voltage	V_{CEO}	-20	V
Emitter-Base Voltage	V_{EBO}	-6	V
Peak Pulse Current	I_{CM}	-10	A
Continuous Collector Current	I_C	-5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4) @ T_A = 25°C	P_D	1	W
Thermal Resistance, Junction to Ambient Air (Note 4) @ T_A = 25°C	$R_{\theta JA}$	125	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Min	Typ	Max	Unit	Conditions
OFF CHARACTERISTICS (Note 5)							
Collector-Base Breakdown Voltage		$V_{(BR)CBO}$	-30	—	—	V	I_C = -50μA, I_E = 0
Collector-Emitter Breakdown Voltage		$V_{(BR)CEO}$	-20	—	—	V	I_C = -1mA, I_B = 0
Emitter-Base Breakdown Voltage		$V_{(BR)EBO}$	-6	—	—	V	I_E = -50μA, I_C = 0
Collector Cut-Off Current		I_{CBO}	—	—	-0.5	μA	V_{CB} = -20V, I_E = 0
Emitter Cut-Off Current		I_{EBO}	—	—	-0.5	μA	V_{EB} = -5V, I_C = 0
ON CHARACTERISTICS (Note 5)							
Collector-Emitter Saturation Voltage		$V_{CE(SAT)}$	—	-0.25	-1.0	V	I_C = -4A, I_B = -0.1A
DC Current Gain	2DB1386Q	h_{FE}	120	—	270	—	I_C = -0.5A, V_{CE} = -2V
	2DB1386R		180	—	390		
SMALL SIGNAL CHARACTERISTICS							
Output Capacitance		C_{obo}	—	55	—	pF	V_{CB} = -20V, I_E = 0, f = 1MHz
Current Gain-Bandwidth Product		f_T	—	100	—	MHz	V_{CE} = -6V, I_E = 50mA, f = 30MHz

Notes: 4. Device mounted on FR-4 PCB; pad layout as shown on page 4 or in Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com.
5. Measured under pulsed conditions. Pulse width = 300μs. Duty cycle ≤2%.

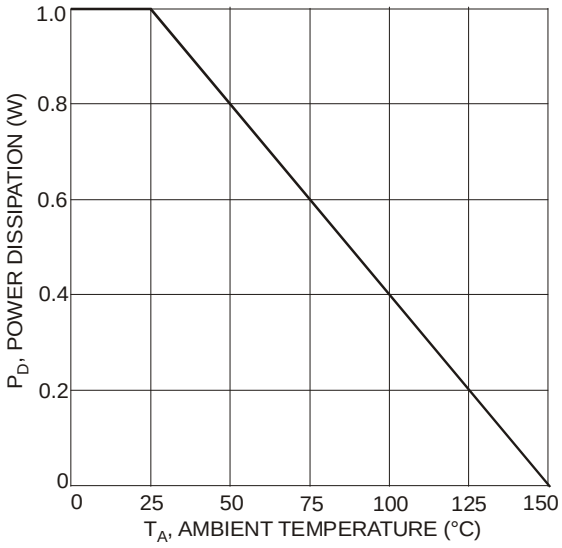


Fig. 1 Power Dissipation vs. Ambient Temperature (Note 4)

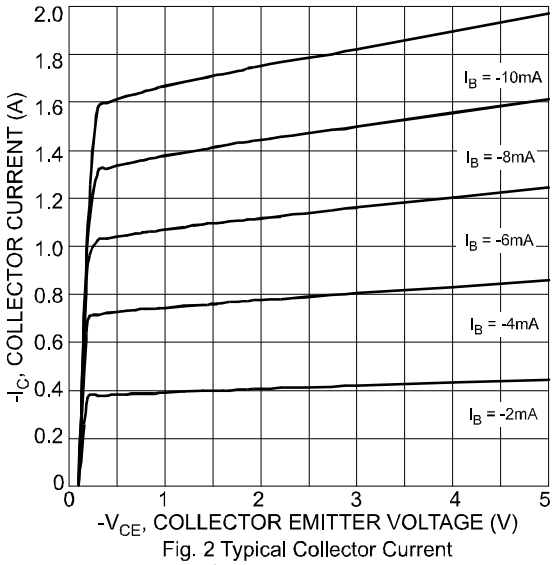


Fig. 2 Typical Collector Current vs. Collector-Emitter Voltage

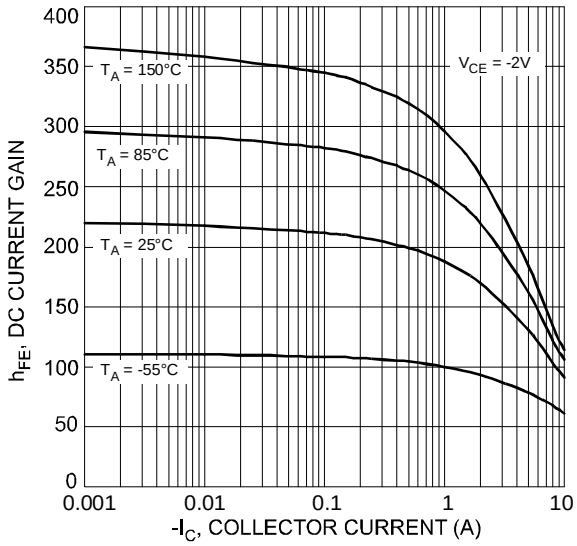


Fig. 3 Typical DC Current Gain vs. Collector Current (2DB1386Q)

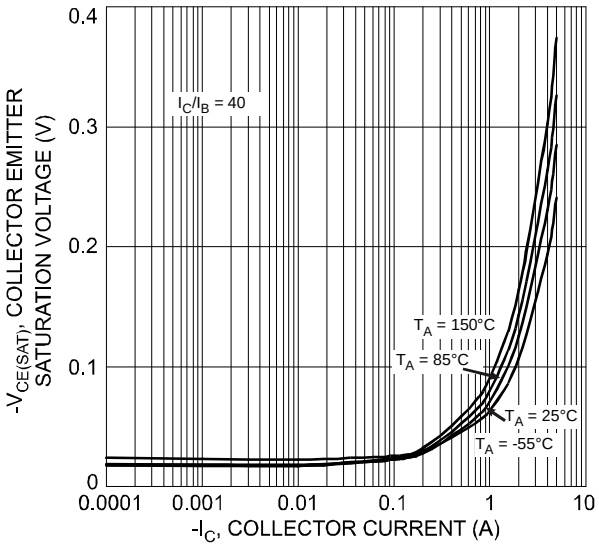


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

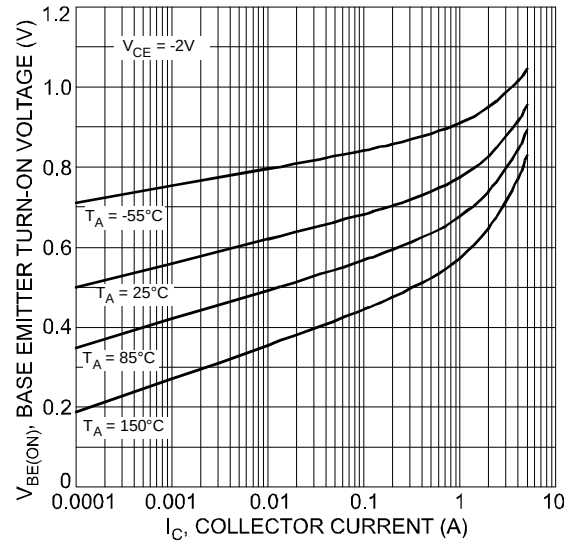


Fig. 5 Typical Base-Emitter Turn-On Voltage vs. Collector Current

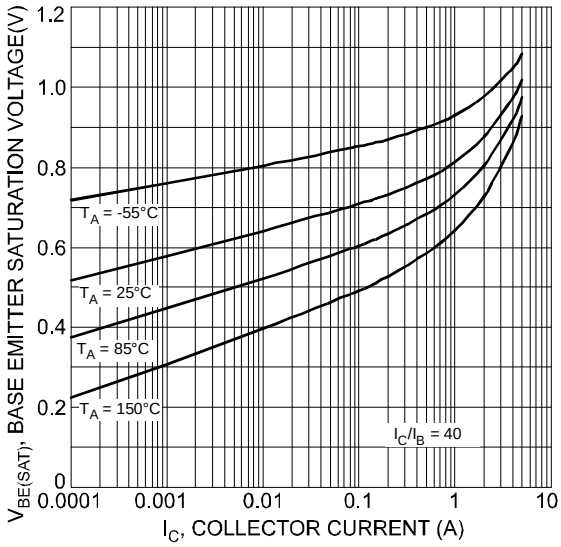


Fig. 6 Typical Base-Emitter Saturation Voltage vs. Collector Current

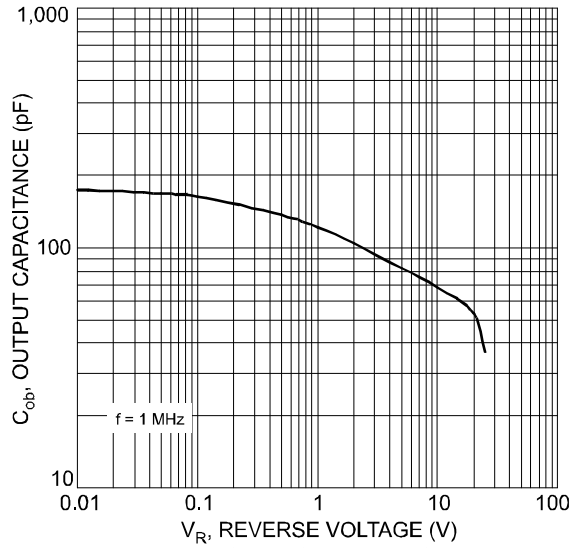


Fig. 7 Typical Output Capacitance Characteristics

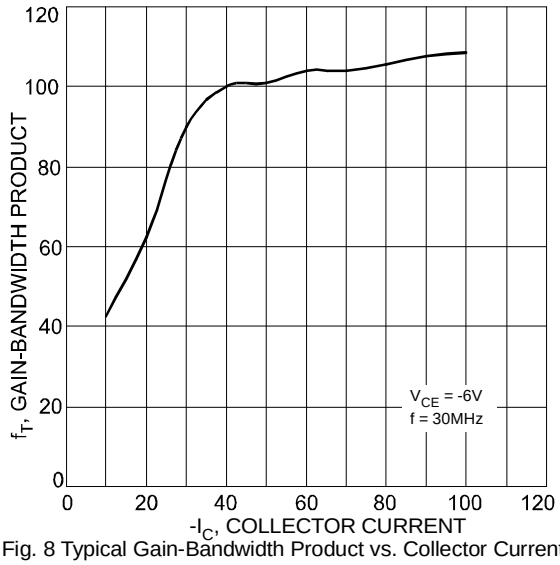
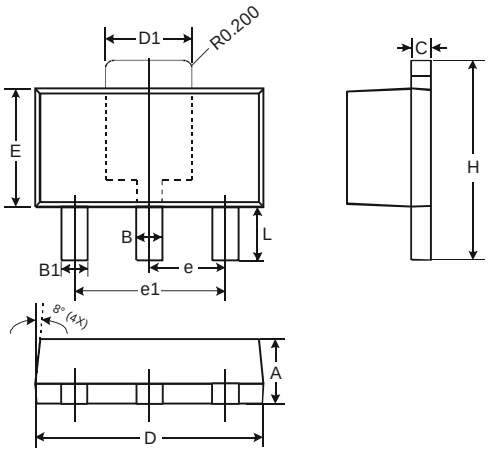


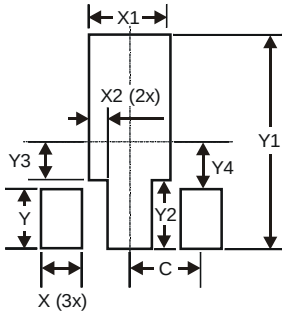
Fig. 8 Typical Gain-Bandwidth Product vs. Collector Current

Package Outline Dimensions



SOT89		
Dim	**Min**	Max
A	1.40	1.60
B	0.44	0.62
B1	0.35	0.54
C	0.35	0.43
D	4.40	4.60
D1	1.52	1.83
E	2.29	2.60
e	1.50 Typ	
e1	3.00 Typ	
H	3.94	4.25
L	0.89	1.20
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
X	0.900
X1	1.733
X2	0.416
Y	1.300
Y1	4.600
Y2	1.475
Y3	0.950
Y4	1.125
C	1.500

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